

International
IR Rectifier

HEXFET® POWER MOSFET THRU-HOLE (TO-257AA)

PD - 94179A

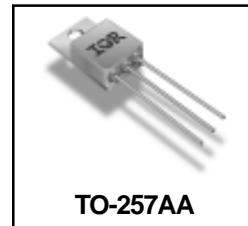
**IRF5Y3205CM
55V, N-CHANNEL**

Product Summary

Part Number	BVDSS	R _{D(on)}	I _D
IRF5Y3205CM	55V	0.022Ω	18A*

Fifth Generation HEXFET® power MOSFETs from International Rectifier utilize advanced processing techniques to achieve the lowest possible on-resistance per silicon unit area. This benefit, combined with the fast switching speed and ruggedized device design that HEXFET power MOSFETs are well known for, provides the designer with an extremely efficient device for use in a wide variety of applications.

These devices are well-suited for applications such as switching power supplies, motor controls, inverters, choppers, audio amplifiers and high-energy pulse circuits.



Features:

- Low R_{D(on)}
- Avalanche Energy Ratings
- Dynamic dv/dt Rating
- Simple Drive Requirements
- Ease of Paralleling
- Hermetically Sealed
- Light Weight

Absolute Maximum Ratings

	Parameter		Units
I _D @ V _{GS} = 10V, T _C = 25°C	Continuous Drain Current	18*	A
I _D @ V _{GS} = 10V, T _C = 100°C	Continuous Drain Current	18*	
I _{DM}	Pulsed Drain Current ①	72	
P _D @ T _C = 25°C	Max. Power Dissipation	100	W
	Linear Derating Factor	0.8	W/°C
V _{GS}	Gate-to-Source Voltage	±20	V
EAS	Single Pulse Avalanche Energy ②	634	mJ
I _{AR}	Avalanche Current ①	18	A
E _{AR}	Repetitive Avalanche Energy ①	10	mJ
dv/dt	Peak Diode Recovery dv/dt ③	2.5	V/ns
T _J	Operating Junction	-55 to 150	°C
T _{STG}	Storage Temperature Range		
	Lead Temperature	300 (0.063in./1.6mm from case for 10sec)	
	Weight	4.3 (Typical)	g

* Current is limited by package

For footnotes refer to the last page

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Electrical Characteristics @ $T_j = 25^\circ\text{C}$ (Unless Otherwise Specified)

	Parameter	Min	Typ	Max	Units	Test Conditions
BV_{DSS}	Drain-to-Source Breakdown Voltage	55	—	—	V	$\text{V}_{\text{GS}} = 0\text{V}, \text{I}_D = 250\mu\text{A}$
$\Delta \text{BV}_{\text{DSS}}/\Delta T_j$	Temperature Coefficient of Breakdown Voltage	—	0.056	—	$\text{V}/^\circ\text{C}$	Reference to 25°C , $\text{I}_D = 1.0\text{mA}$
$R_{\text{DS}(\text{on})}$	Static Drain-to-Source On-State Resistance	—	—	0.022	Ω	$\text{V}_{\text{GS}} = 10\text{V}, \text{I}_D = 18\text{A}$ ④
$\text{V}_{\text{GS}(\text{th})}$	Gate Threshold Voltage	2.0	—	4.0	V	$\text{V}_{\text{DS}} = \text{V}_{\text{GS}}, \text{I}_D = 250\mu\text{A}$
g_{fs}	Forward Transconductance	18	—	—	S (Ω)	$\text{V}_{\text{DS}} = 15\text{V}, \text{I}_{\text{DS}} = 18\text{A}$ ④
I_{DSS}	Zero Gate Voltage Drain Current	—	—	25	μA	$\text{V}_{\text{DS}} = 55\text{V}, \text{V}_{\text{GS}} = 0\text{V}$
		—	—	250		$\text{V}_{\text{DS}} = 44\text{V}, \text{V}_{\text{GS}} = 0\text{V}, T_j = 125^\circ\text{C}$
I_{GSS}	Gate-to-Source Leakage Forward	—	—	100	nA	$\text{V}_{\text{GS}} = 20\text{V}$
I_{GSS}	Gate-to-Source Leakage Reverse	—	—	-100		$\text{V}_{\text{GS}} = -20\text{V}$
Q_g	Total Gate Charge	—	—	170	nC	$\text{V}_{\text{GS}} = 10\text{V}, \text{I}_D = 18\text{A}$
Q_{gs}	Gate-to-Source Charge	—	—	32		$\text{V}_{\text{DS}} = 44\text{V}$
Q_{gd}	Gate-to-Drain ('Miller') Charge	—	—	74	ns	$\text{V}_{\text{DD}} = 28\text{V}, \text{I}_D = 18\text{A}, \text{V}_{\text{GS}} = 10\text{V}, \text{R}_G = 2.5\Omega$
$t_{\text{d}(\text{on})}$	Turn-On Delay Time	—	—	22		
t_r	Rise Time	—	—	80		
$t_{\text{d}(\text{off})}$	Turn-Off Delay Time	—	—	70		
t_f	Fall Time	—	—	55		
$L_S + L_D$	Total Inductance	—	6.8	—	nH	Measured from drain lead (6mm/0.25in. from package) to source lead (6mm/0.25in. from package)
C_{iss}	Input Capacitance	—	3660	—	pF	$\text{V}_{\text{GS}} = 0\text{V}, \text{V}_{\text{DS}} = 25\text{V}$ $f = 1.0\text{MHz}$
C_{oss}	Output Capacitance	—	1200	—		
C_{rss}	Reverse Transfer Capacitance	—	440	—		

Source-Drain Diode Ratings and Characteristics

	Parameter	Min	Typ	Max	Units	Test Conditions
I_S	Continuous Source Current (Body Diode)	—	—	18*	A	$T_j = 25^\circ\text{C}, I_S = 18\text{A}, \text{V}_{\text{GS}} = 0\text{V}$ ④
I_{SM}	Pulse Source Current (Body Diode) ①	—	—	72		
V_{SD}	Diode Forward Voltage	—	—	1.3	V	$T_j = 25^\circ\text{C}, I_F = 18\text{A}, dI/dt \leq 100\text{A}/\mu\text{s}$
t_{rr}	Reverse Recovery Time	—	—	130	ns	$V_{\text{DD}} \leq 30\text{V}$ ④
Q_{RR}	Reverse Recovery Charge	—	—	410	nC	
t_{on}	Forward Turn-On Time	Intrinsic turn-on time is negligible. Turn-on speed is substantially controlled by $L_S + L_D$.				

* Current is limited by package

Thermal Resistance

	Parameter	Min	Typ	Max	Units	Test Conditions
R_{thJC}	Junction-to-Case	—	—	1.25	$^\circ\text{C/W}$	

Note: Corresponding Spice and Saber models are available on the G&S Website.

For footnotes refer to the last page

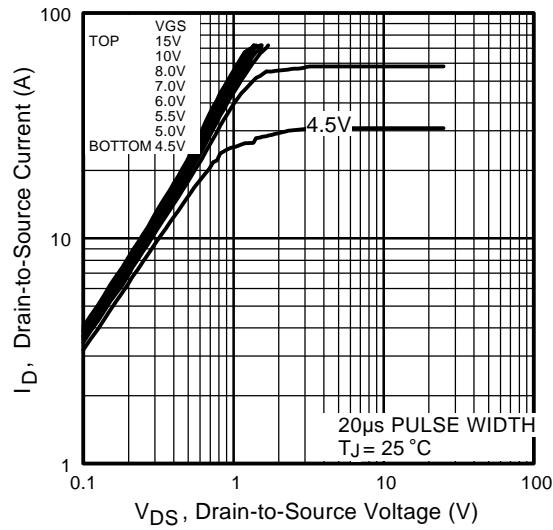


Fig 1. Typical Output Characteristics

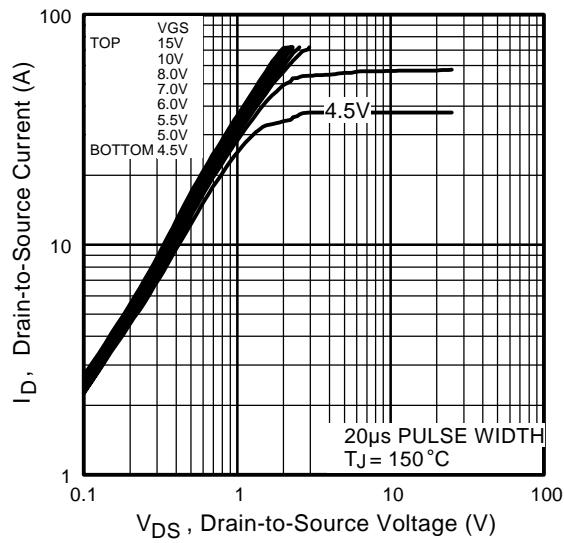


Fig 2. Typical Output Characteristics

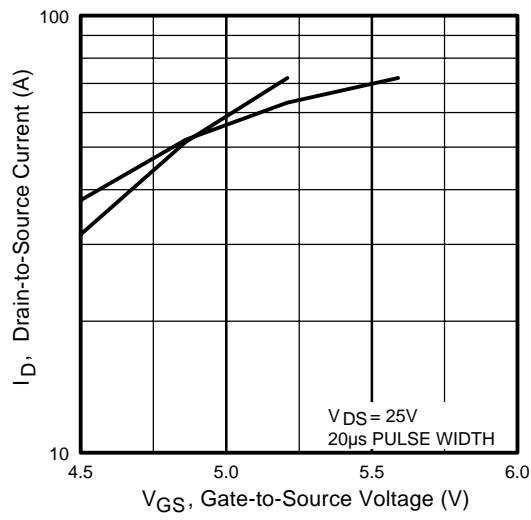


Fig 3. Typical Transfer Characteristics

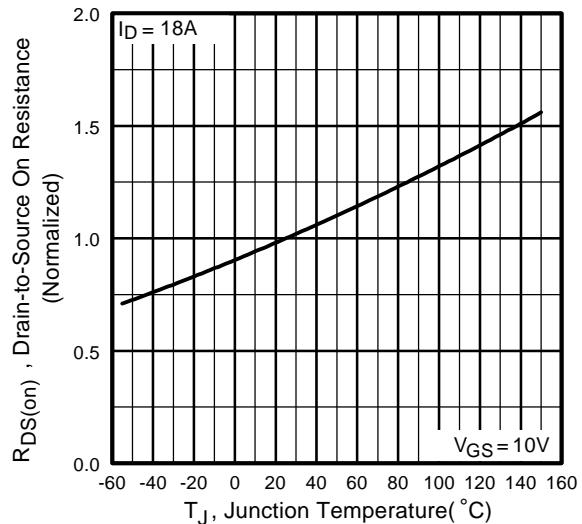


Fig 4. Normalized On-Resistance
Vs. Temperature

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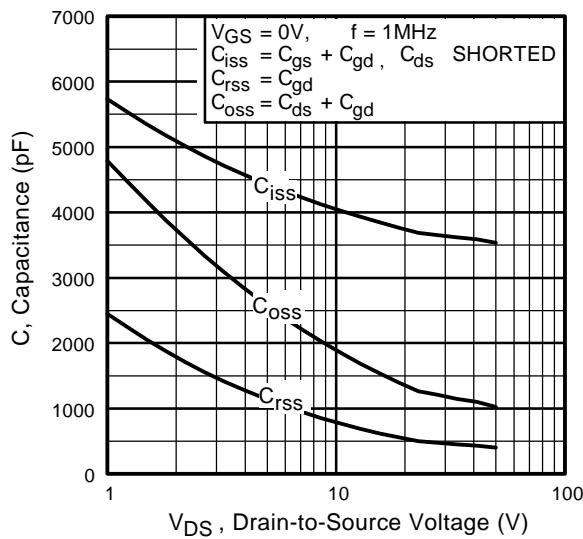


Fig 5. Typical Capacitance Vs.
Drain-to-Source Voltage

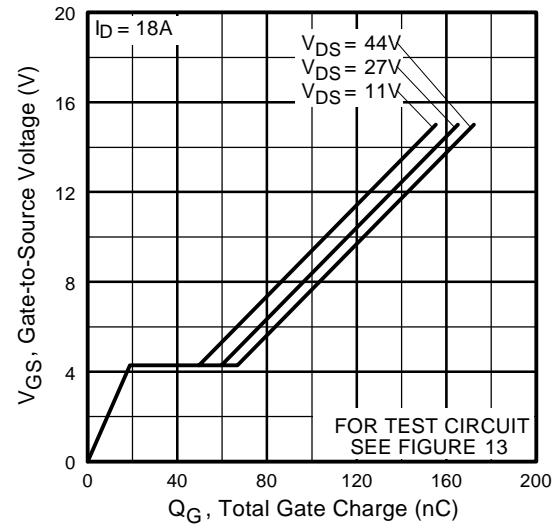


Fig 6. Typical Gate Charge Vs.
Gate-to-Source Voltage

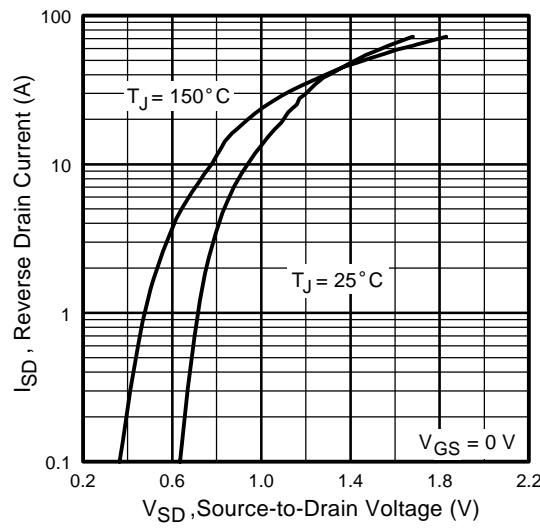


Fig 7. Typical Source-Drain Diode
Forward Voltage

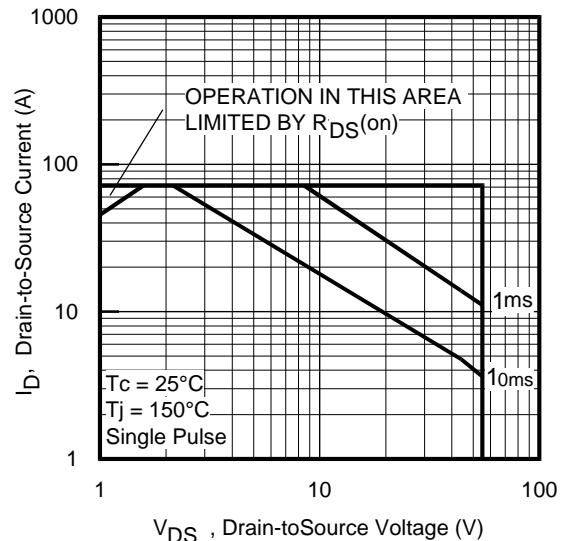


Fig 8. Maximum Safe Operating Area

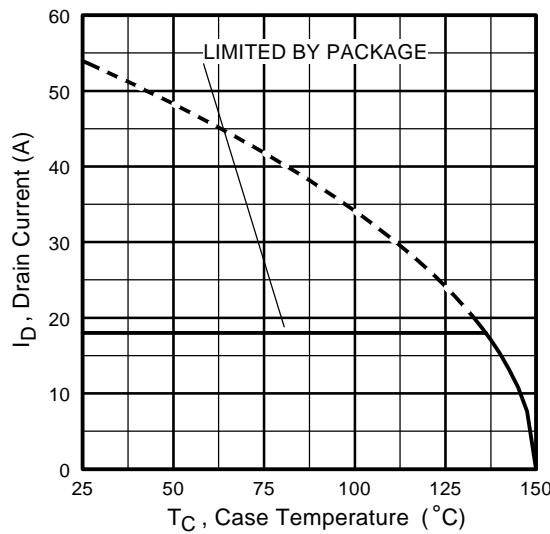


Fig 9. Maximum Drain Current Vs.
Case Temperature

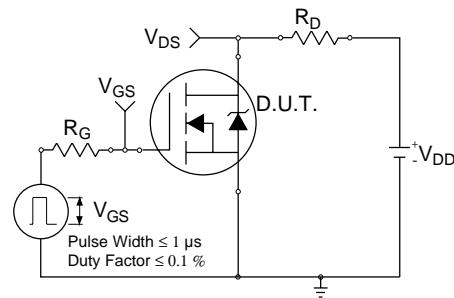


Fig 10a. Switching Time Test Circuit

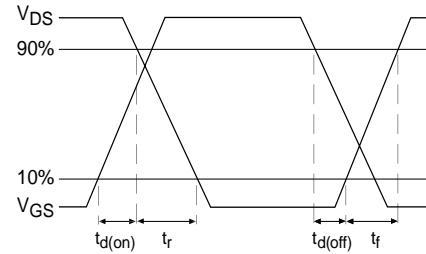


Fig 10b. Switching Time Waveforms

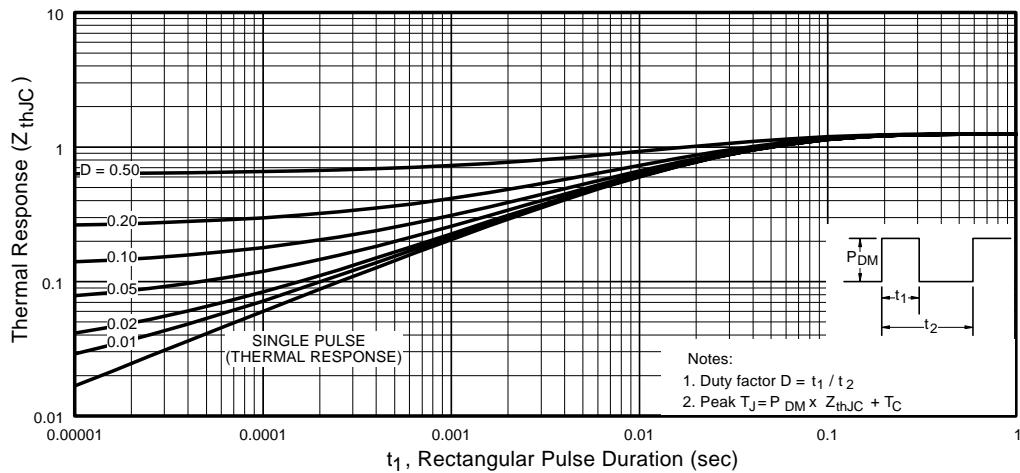
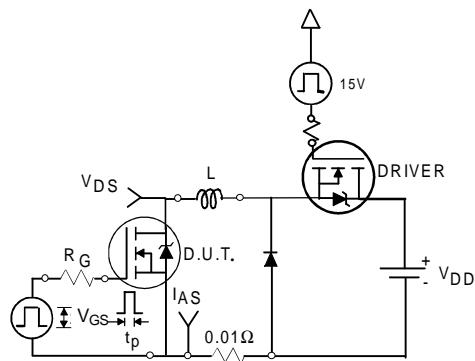
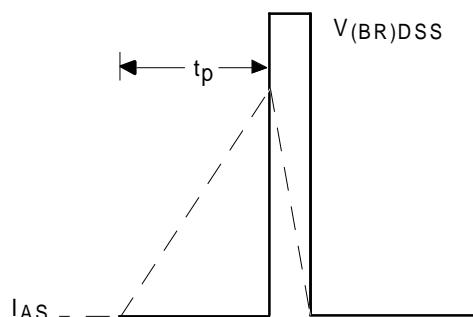
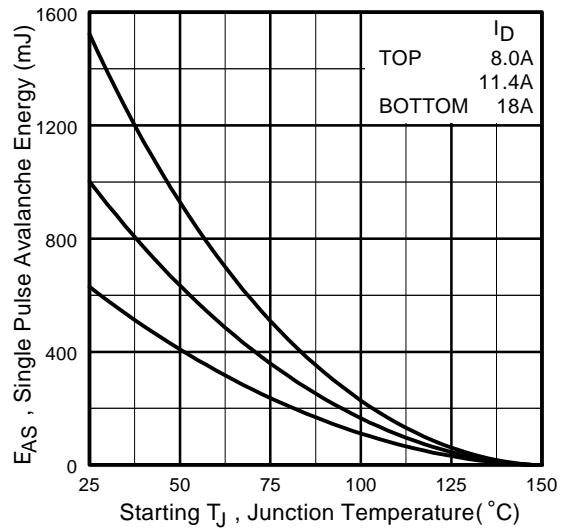
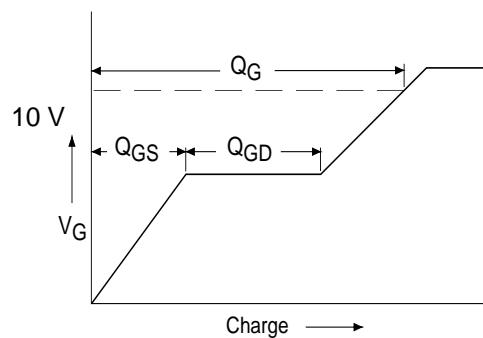
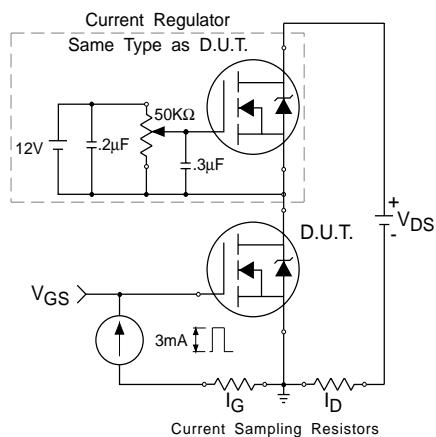


Fig 11. Maximum Effective Transient Thermal Impedance, Junction-to-Case

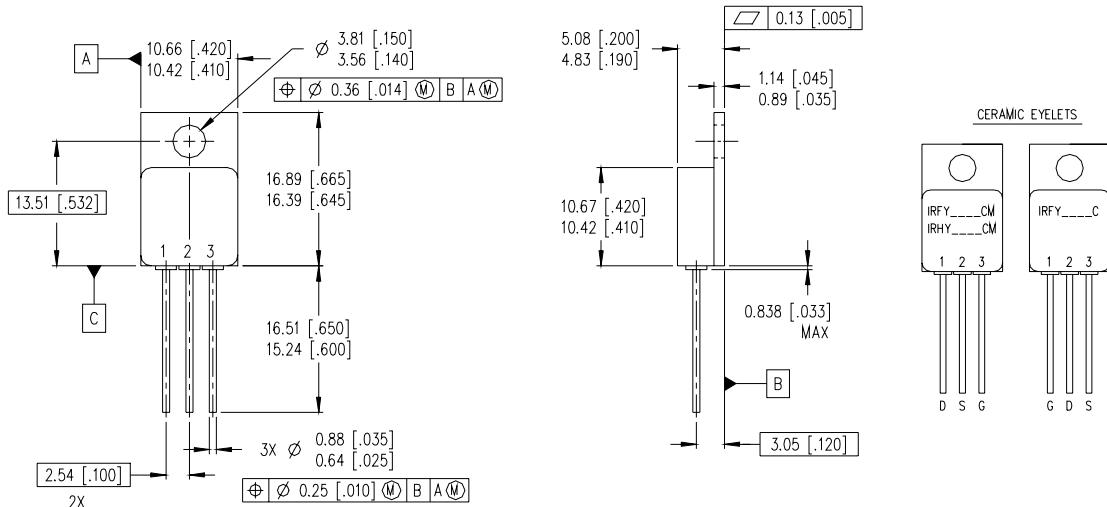
**Fig 12a.** Unclamped Inductive Test Circuit**Fig 12b.** Unclamped Inductive Waveforms**Fig 12c.** Maximum Avalanche Energy Vs. Drain Current**Fig 13a.** Basic Gate Charge Waveform**Fig 13b.** Gate Charge Test Circuit

Footnotes:

- ① Repetitive Rating; Pulse width limited by maximum junction temperature.
- ② V_{DD} = 25 V, Starting T_J = 25°C, L= 3.9mH
Peak I_{AS} = 18A, V_{GS} =10V, R_G= 25Ω

- ③ I_{SD} ≤ 18A, di/dt ≤ 230 A/μs,
V_{DD} ≤ 100V, T_J ≤ 150°C
- ④ Pulse width ≤ 300 μs; Duty Cycle ≤ 2%

Case Outline and Dimensions — TO-257AA



NOTES:

1. DIMENSIONING & TOLERANCING PER ANSI Y14.5M-1994.
2. CONTROLLING DIMENSION: INCH.
3. DIMENSIONS ARE SHOWN IN MILLIMETERS [INCHES].
4. OUTLINE CONFORMS TO JEDEC OUTLINE TO-257AA.

LEGEND
 D – DRAIN
 S – SOURCE
 G – GATE

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